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Δnnli	cation Da	ta Sheet 3	7 CER	76	Attorne	y Doci	cet No	ımber	P302	15	
Application Data Sheet 37 CFR 1.7			0	Applica	ation N	umbe	r				
Title of	Title of Invention   SOLDER COMPOSITION AND METHOD OF BUMP FORMATION THEREWITH										
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City	Tokyo		- 1	Count	try Of Re	siden	ei	JP			
Citizer	ship unde	r 37 CFR 1.4	(b) i	JP							
Mailin	g Address	of Applicant									
Addre	ss 1	c/o TA	MURA CO	RPOR	RATION						
Addre	ss 2	1-19-4	3, Higashi	-oizum	ii, Nerima-	ku					
City	Tokyo						State	/Provin	ice		
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Applic	ant 2									Remove	
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	Macabiko			+				_	CUDI		

Residence Information (Select One) US Residency Non US Residency Active US Military Service

Country Of Residence

Tokyo

Application Data Sheet 37 CFF			CED 17	Attorney Docket Number			P30245						
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Title of I	Invention	SOLDER COMPOSITION AND METHOD OF BUMP FORMATION THEREWITH											
Citizens	ship under	37 CFR 1.41(I	b) i JP										
Mailing	Address of	Applicant:											
Addres	s 1	c/o TAM	URA CORE	PORATION									
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Application Data Sheet 37 CFR 1.76

P30245

Mailing Address of Applicant:  Address 1															
Address 1 of TAMURA CORPORATION   Address 2 1-16-43, Higaelh-cozum, Nerma-ku   Countryl JP   Postal Code   Countryl JP   Remove   Replicant Authority © Inventor   Legal Representative under 35 U.S.C. 117   Pethy of Interest under 35 U.S.C. 117   Pethy of Interest under 35 U.S.C. 117   Pethy of Interest under 35 U.S.C. 118   Residence information (Select One)   U.Sequil Representative under 35 U.S.C. 117   Pethy I Survey   Residence information (Select One)   U.Sequil Representative under 35 U.S.C. 117   Pethy I Survey   Residence information (Select One)   U.Sequil Representative under 37 U.S.C. 118   Residence information (Select One)   U.Sequil Representative under 37 U.S.C. 118   Residence information (Select One)   U.Sequil Representative under 37 U.S.C. 118   Residence information (Select One)   U.Sequil Representative under 37 U.S.C. 118   Residence information (Select One)   U.Sequil Representative under 37 U.S.C. 118   Residence information (Select One)   U.Sequil Representative under 37 U.S.C. 118   Residence information (Select One)   U.Sequil Representative under 37 U.S.C. 118   Residence information (Select One)   U.Sequil Representative under 37 U.S.C. 118   Residence information (Select One)   U.Sequil Representative under 37 U.S.C. 118   Residence information (Select One)   U.S.C. 118   Residence information (	Title of Invention   SOLDER COMPOSITION AND METHOD OF BUMP FORMATION THEREWITH														
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Citizenship under 37 CFR 1.41(b)   JP  Mailing Address of Applicant:  Address 1 of TAMURA CORPORATION  Address 2 1-19-43, Higash-ozunit, Nermaku  City Toyo  Postal Code  Postal Code  Postal Code  Country JP  All Inventors Must Be Listed - Additional inventor Information blocks may be generated within this form by selecting the Add button.  Correspondence Information:  Enter either Customer Number or complete the Correspondence Information section below.  For further information sea 37 CFR 1.34(a),  Address is being provided for the correspondence Information of this application.  Customer Number of 07055  Customer Number of 07055  Email Address (gipatent@oppatent.com Add Email [Remove Email Address gipatent@oppatent.com Address Email Remove Email Remove Email Address (gipatent@oppatent.com Address Email Remove Em	Residence	e Informatio	n (Select One	0	US Resideni	oy ⊙	Non	US Res	idency	О	Activ	e US	Military	Servio	e
Mailing Address of Applicants  Address 1 of TAMURA CORPORATION  Address 2 1-19-43, Higash-oczuni, Nerma-ku  City Totyo State/Province  Postal Code Country J.P  All Iliventors Must Be Listed - Additional Inventor Information blocks may be generated within this form by selecting the Add button.  Correspondence Information:  Enter either Customer Number or complete the Correspondence Information section below. For further Information see 37 CFR 1.33(a).  ———————————————————————————————————	City Tok	yo		Co	untry Of Re	esidence	i	JP							
Address 1 or TAMURA CORPORATION  Address 2 1-19-43, Higash-corum, Nerma-ku  City Toryo State/Province  Postal Code Country   JP  All Inventors Mast Be Listed - Additional Inventor Information  Address   Additional Inventor Information   Additional Information   Additional Information   Additional Information   Additional Information   Additional Information   Information   Additional Information   Additional Information   Information   Additional Infor				JP											
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City Tokyo State/Province  Postal Code Country J.P  All inventors Must Be Listed - Additional Inventor Information  Correspondence Information:  Enter either Customer Number or complete the Correspondence Information section below.  For further information see 37 CFR 1.33(a).  An Address is being provided for the correspondence Information of this application.  Customer Number of 07055  Email Address gpatent@spatent.com Add Email (Interest Manager Country)  Application Information:  Title of the Invention  SULDER COMPOSITION AND METHOD OF BUMP FORMATION THEREWITH  Application Type  Nonprovisional  Number Country Supposed Class (If any)  Suggested Class (If any)  Suggested Technology Center (If any)															
Postal Code All Inventors Must Be Listed - Additional Inventor Information blocks may be generated within this form by selecting the Add bitton.  Correspondence Information: Enter either Customer Number or complete the Correspondence Information section below. For further information sea? Toff 1.3(a)e.  And Address is being provided for the correspondence Information of this application.  Customer Number of 0505  Customer Number of 0505  Email Address (gipatent@oppatent.com Add Email Remove Email Address)  Application Information:  Title of the Invention SOLIDER COMPOSITION AND METHOD OF BUMP FORMATION THEREWITH Attorney Docket Number PO0245 Small Entity Status Claimed   Application Type Nongrovescent Subject Marter Utility Suggested Technology Center (if any) Suggested Technology Center (if any)			1-19-43, Higa	shi-oiz	umi, Nerima										
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For further information see 3 CPR 1.33(a).  An Address is being provided for the correspondence information of this application.  Customer Number 07055  Email Address gbpatent@sppatent.com Add Email [Numous Email Address]  Application Information:  Title of the invention SOLDER COMPOSITION AND METHOD OF BUMP FORMATION THEREWITH PRO2015  Application Type Nonprovisional Number Proceedings of the Invention Number Proceedings of the Invention Number Pro2015  Subject Matter Unity Supposed Class (if any) Sugessed Technology Center (if any)	Correspo	ondence	Informati	on:											
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Application Information:  Title of the Invention   SOLDER COMPOSITION AND METHOD OF BUMIP FORMATION THEREWITH   Attorney Docket Number   P90245   Small Entity Status Claimed   Application Type   Nongrovisional   Subject Matter   Utility   Suggested Class (if any)   Suggested Technology Center (if any)	Customer	Number	07055												
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Publication Information:								
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Request Not to Publish. Thereby request that the attached application not be published under 35 U.S. C. 122(b) and cotify that the invention disclosed in the state-ded application has not been and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.								

### Representative Information:

Representative information should be provided for all practitioners having a power of attorney in the application. Providing this information in the Application Data Sheet does not constitute a power of attorney in the application (see 37 CFR 1.32). Enter either Customer Number or complete the Representative Name section below. If both sections are completed the Customer Number will be used for the Representative Information during processing.

Please Select One:	Customer Number	US Patent Practitioner	US Representative (37 CFR 11.9)
Customer Number	07055		

# Domestic Priority Information:

This section allows for the applicant to claim benefit under 35 U.S.C. 119(e), 120, 121, or 365(c). Providing this information in the application data sheet constitutes the specific reference required by 35 U.S.C. 119(e) or 120, and 37 CFR 1.78(a)(2) or CFR 1.78(a) nuna ha mada part of the specific

(4), and need not obtained be made part of the specimental.								
Prior Application Status	Pending	Remove						
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## Foreign Priority Information:

This section allows for the applicant to claim benefit of foreign priority and to identify any prior foreign application for which priority is not claimed. Providing this information in the application data sheet constitutes the claim for priority as required by 35 U.S.C. 119(b) and 37 CFR 1.55(a).

		100	III.						
Application Number	Country i	Parent Filing Date (YYYY-MM-DD)	Priority Claimed						
2004/082467	JP	2004-03-22	Yes ○ No						
Additional Foreign Priority Data may be generated within this form by selecting the									

#### Assignee Information:

Providing this information in the application data sheet does not substitute for compliance with any requirement of part 3 of Title 37 of the CER to have an assignment recorded in the Office

Assignee 1 If the Assignee is an Organization check here. 

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Application Data Sheet 37 CFR 1.76			Attorney Docket Number		P30245		
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Organization Name	т,	AMURA CORPORATIO	N .				
Mailing Address I	nforma	tion:					
Address 1		1-19-43, Higashi-oiz	umi, Nerima-ku				
Address 2							
City		Tokyo		State/Provin	ce		
Country   JP				Postal Code			
Phone Number				Fax Number			
Email Address							
Assignee 2						Remove	
If the Assignee is a	n Organ	nization check here.	✓				
Organization Name	Ja	apan Science and Tech	nology Agency				
Mailing Address I	nforma	tion:					
Address 1		4-1-8, Honcho, Kaw	aguchi-shi,				
Address 2							
City		Saitama		State/Provin	ce		
Country JP	Country   JP			Postal Code			
Phone Number				Fax Number			
Email Address	Email Address						
Additional Assignee Data may be generated within this form by selecting the Add button.							
Signature:							

A signature of the applicant or representative is required in accordance with 37 CFR 1.33 and 10.18. Please see 37

CFR 1.4(d) to	CFR 1.4(d) for the form of the signature.										
Signature	/Bruce H. Bernstein/		Date (YYYY-MM-DD)	2006-08-17							
First Name	irst Name Bruce H.		Bernstein	Registration Number	29,027						

This collection of information is required by 37 CFR 1.76. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1 14. This collection is estimated to take 23 minutes to complete, including gathering, preparing, and submitting the completed application data sheet form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450, DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents. P.O. Box 1450. Alexandria, VA 22313-1450.

#### Privacy Act Statement

The Privacy Act of 1974 (P. 9. 36-379) inequases that jour to given certain information is connection with jour submission of the attracted from related to a potent application of post application of post and post application of the information is 30 U.S.C. (20)(2); (2) Intrinsiting of the information is solded in such post application post post in which the information is used by the U.S. Patient and Traderess Office on postess and post application of post in 1900 post of post application of post in 1900 post application of post in 1900 post in 1900 post application of post in 1900 post in 1900 post in 1900 post in 1900 post application of post in 1900 post application of post in 1900 post in

The information provided by you in this form will be subject to the following routine uses:

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